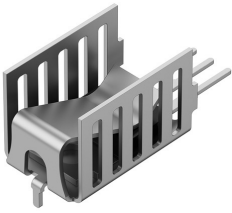


## Data sheet Product FK 261 MI 220 H



Board Level heatsinks>Attachable heatsink

- universal clip-on heatsinks for design TO 220 and similar
- integrated clamp geometry for a secure fixing of the device
- angled designs with enlarged surface
- modifications and special designs according to customer's specifications

### Features

material:	copper (Cu)
for transistor:	<ul style="list-style-type: none"> <li>• TO 220</li> <li>• TO 248</li> <li>• SIP-Multiwatt</li> <li>• TO 247</li> <li>• TO 218</li> </ul>
width:	13 mm
height:	13 mm
length:	21 mm
thermal resistance:	24.1 K/W
surface:	solderable surface
version:	with solder lug for horizontal installation
material thickness:	0.6 mm

### Technical Drawing

24,1 K/W

